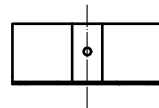
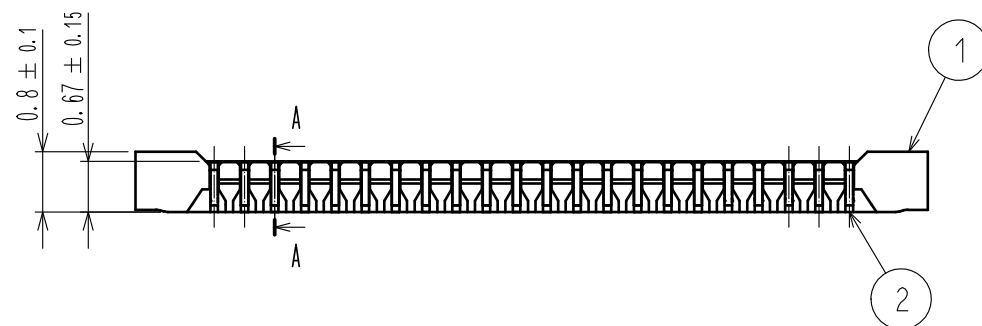
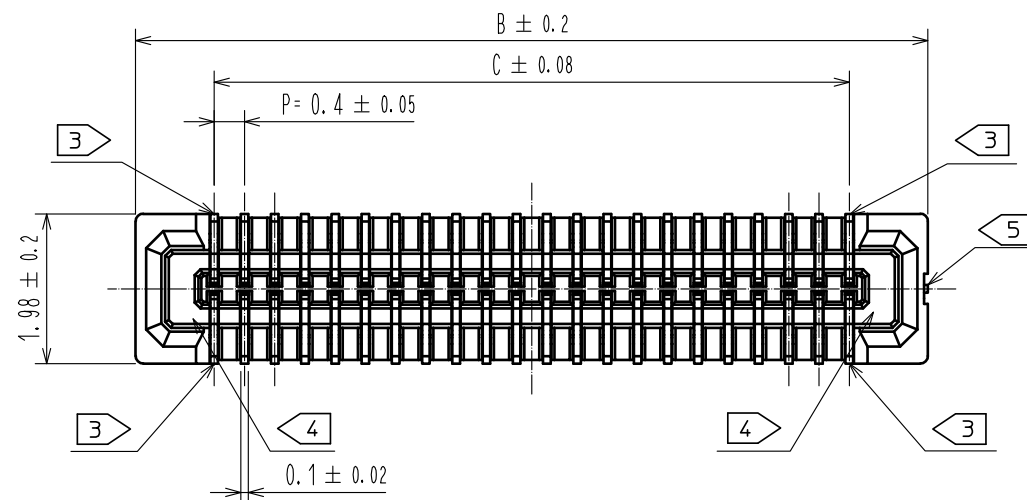


Apr.1.2025 Copyright 2025 HIROSE ELECTRIC CO., LTD. All Rights Reserved.
In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.



NOTE) 1. ALL LEAD CO-PLANARITY SHALL BE 0.08mm MAX

2. CONTACT PLATING SPECIFICATIONS.

CONTACT AREA : GOLD 0.05 μm MIN

SMT LEAD : GOLD 0.05 μm MIN

UNDERPLATING : NICKEL 1 μm MIN

(SURFACE : SEALING)

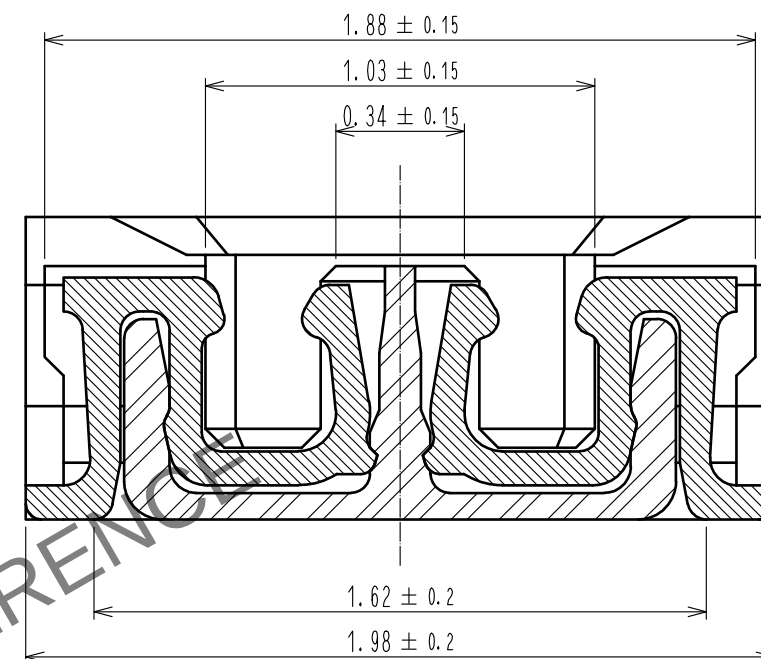
3. EACH CONTACTS AT 4 CORNERS ARE PROVIDED FOR METAL FITTINGS AND GROUNDING PURPOSE.

4. HRS MARK AND CAV NO. ARE INDICATED IN APPROX POSITION SHOWN.

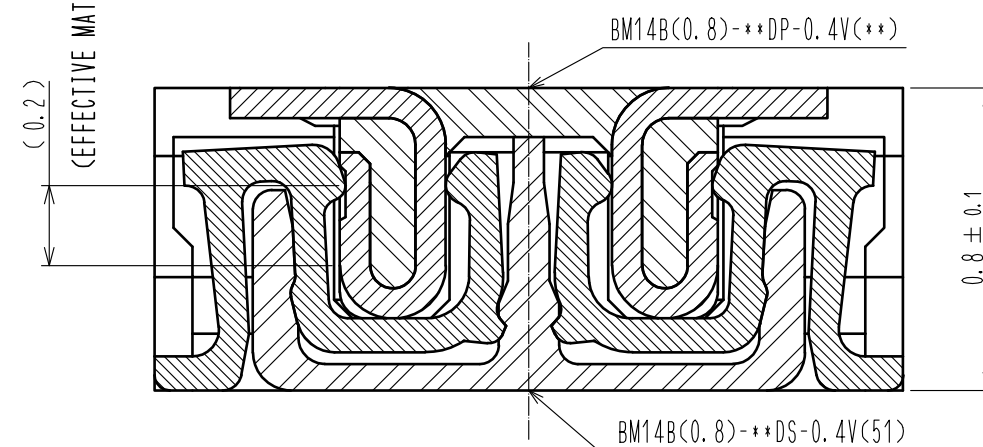
5. GATE POSITION IS INDICATED IN APPROX POSITION SHOWN.

PART No.	CODE No.	B	C
BM14B(0.8)-10DS-0.4V(51)	CL684-8003-5-51	4.48	2.4
BM14B(0.8)-12DS-0.4V(51)	CL684-8041-4-51	4.88	2.8
BM14B(0.8)-20DS-0.4V(51)	CL684-8004-8-51	6.48	4.4
BM14B(0.8)-22DS-0.4V(51)	-	6.88	4.8
BM14B(0.8)-24DS-0.4V(51)	CL684-8005-0-51	7.28	5.2
BM14B(0.8)-30DS-0.4V(51)	CL684-8006-3-51	8.48	6.4
BM14B(0.8)-34DS-0.4V(51)	CL684-8007-6-51	9.28	7.2
BM14B(0.8)-40DS-0.4V(51)	CL684-8008-9-51	10.48	8.4
BM14B(0.8)-50DS-0.4V(51)	CL684-8009-1-51	12.48	10.4
BM14B(0.8)-60DS-0.4V(51)	CL684-8001-0-51	14.48	12.4

A-A (50:1)

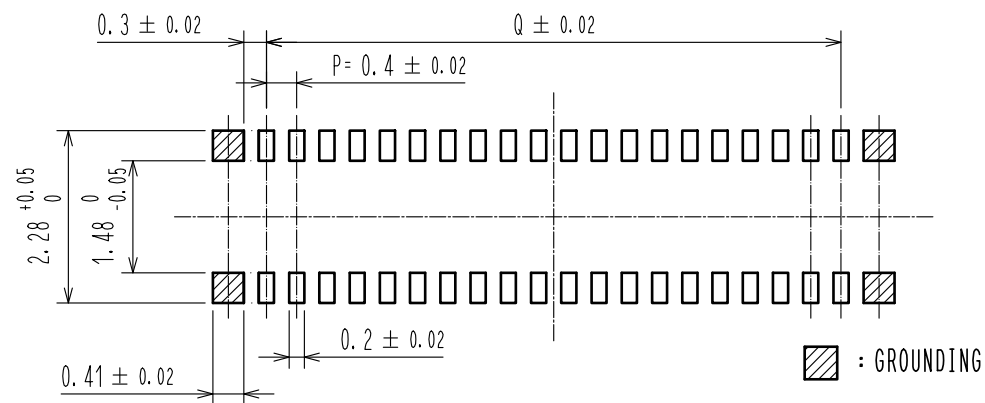


ENGAGEMENT FIGURE (50:1)



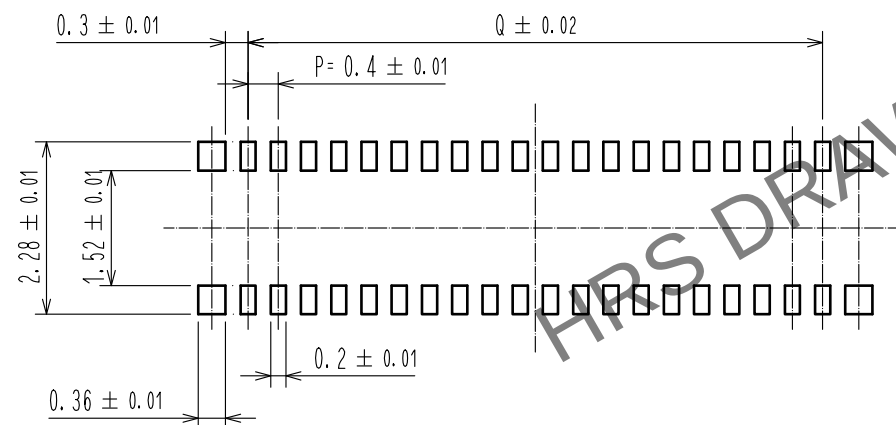
3	PS	CLEAR (ENBOSSED CARRIER TAPE)	6	PS	CLEAR (REINFORCEMENT COLLAR)
2	PHOSPHOR BRONZE	2	5	PS	BLACK (PLASTIC REEL)
1	LCP	UL94 V-0, BLACK	4	POLYESTER	CLEAR (COVER TAPE)
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm		SCALE 10:1	COUNT 1	DESCRIPTION OF REVISIONS DIS-H-00003048	DESIGNED NY. YAMASHIRO
APPROVED : KH. IKEDA 09.11.24				DRAWING NO. EDC3-322327-04	
CHECKED : WR. FUKUCHI 09.11.24				PART NO. BM14B(0.8)-*DS-0.4V(51)	
DESIGNED : YH. HASEGAWA 09.11.20				CODE NO. CL684	
DRAWN : YH. HASEGAWA 09.11.20				DATE 17.09.29	

◆ RECOMMENDED PCB LAYOUT



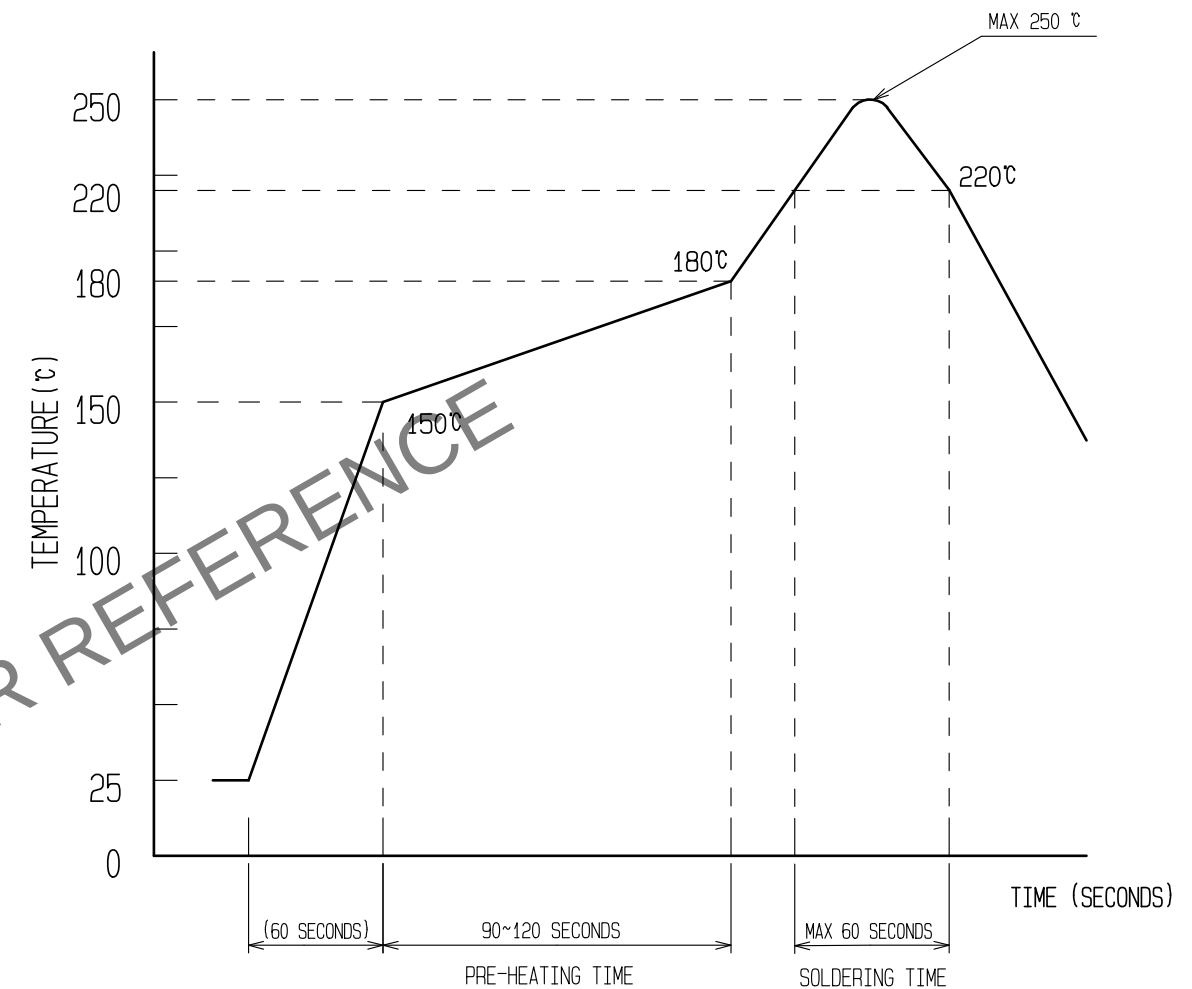
◆ RECOMMENDED METAL MASK DIMENSIONS

METAL MASK THICKNESS : 100 μ m



PART No.	Q
BM14B(0.8)-10DS-0.4V(51)	1.6
BM14B(0.8)-12DS-0.4V(51)	2.0
BM14B(0.8)-20DS-0.4V(51)	3.6
BM14B(0.8)-22DS-0.4V(51)	4.0
BM14B(0.8)-24DS-0.4V(51)	4.4
BM14B(0.8)-30DS-0.4V(51)	5.6
BM14B(0.8)-34DS-0.4V(51)	6.4
BM14B(0.8)-40DS-0.4V(51)	7.6
BM14B(0.8)-50DS-0.4V(51)	9.6
BM14B(0.8)-60DS-0.4V(51)	11.6

6 RECOMMENDED REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE.



REFLOW METHOD: IR REFLOW
NUMBER OF REFLOW CYCLES: 2 CYCLES MAX.

- 1) REFLOW TIME
DURATION ABOVE 220°C, 60 SEC. MAX.
(PEAK TEMPERATURE: 250°C MAX)
- 2) PRE-HEAT TIME
PRE-HEAT TEMPERATURE(MIN): 150°C
PRE-HEAT TEMPERATURE(MAX): 180°C
PRE-HEAT TIME: 90-120 sec.

6 THIS TEMPERATURE PROFILE IS PER THE CONDITIONS SHOWN ABOVE.
ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE, PCB SIZE AND
OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE, THEREFORE,
A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED
PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.

HRS

DRAWING NO.	EDC3-322327-04
PART NO.	BM14B(0.8)-*DS-0.4V(51)
CODE NO.	CL684

